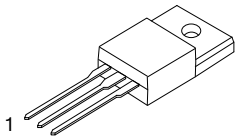
2N90Z

Power MOSFET

2A, 900V N-CHANNEL POWER MOSFET



TO-220F

■ DESCRIPTION

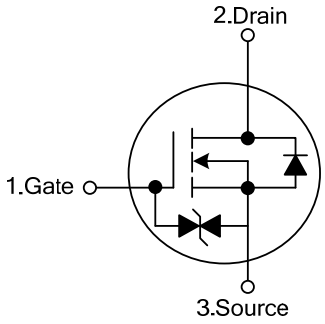
The UTC **2N90Z** is an N-channel mode power MOSFET using UTC's advanced technology to provide costumers with planar stripe and DMOS technology. This technology specialized in allowing a minimum on-state resistance and superior switching performance. It also can withstand high energy pulse in the avalanche and commutation mode.

The UTC **2N90Z** is universally applied in high efficiency switch mode power supply.

■ FEATURES

* $R_{DS(ON)}$ = 7.2Ω @V_{GS} = 10 V
* Typically 5.5 pF low C_{RSS}
* High switching speed
* Typically 12nC low gate charge
* Improved dv/dt capability
* 100% avalanche tested

■ SYMBOL



■ ORDERING INFORMATION

Ordering Number		Package	Pin Assignment			Packing
Lead Free	Halogen Free		1	2	3	
2N90ZL-TF3-T	2N90ZG-TF3-T	TO-220F	G	D	S	Tube

Note: Pin Assignment: G: Gate D: Drain S: Source

2N90ZL-TA3-T (1)Packing Type (2)Package Type (3)Lead Free	(1) T: Tube (2) TF3: TO-220F (3) G: Halogen Free, L: Lead Free

■ ABSOLUTE MAXIMUM RATINGS (T_C=25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT
Drain-Source Voltage (Note 2)		V_{DSS}	900	V
Gate-Source Voltage		V_{GSS}	±20	V
Drain Current	Continuous	I_D	2.2	A
	Pulsed (Note 2)	I_{DM}	8.8	A
Avalanche Current (Note 2)		I_{AR}	2.2	A
Avalanche Energy	Single Pulsed (Note 3)	E_{AS}	170	mJ
	Repetitive (Note 2)	E_{AR}	8.5	mJ
Peak Diode Recovery dv/dt (Note 4)		dv/dt	4.0	V/ns
Power Dissipation		P_D	25	W
Junction Temperature		T_J	+150	°C
Storage Temperature		T_{STG}	-55~+150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.
2. Repetitive Rating: Pulse width limited by maximum junction temperature
3. L = 65mH, I_{AS} = 2.2A, V_{DD} = 50V, R_G = 25Ω, Starting T_J = 25°C
4. I_{SD} ≤ 2.2A, di/dt ≤ 200A/μs, V_{DD} ≤ BV_{DSS}, Starting T_J = 25°C

■ THERMAL DATA

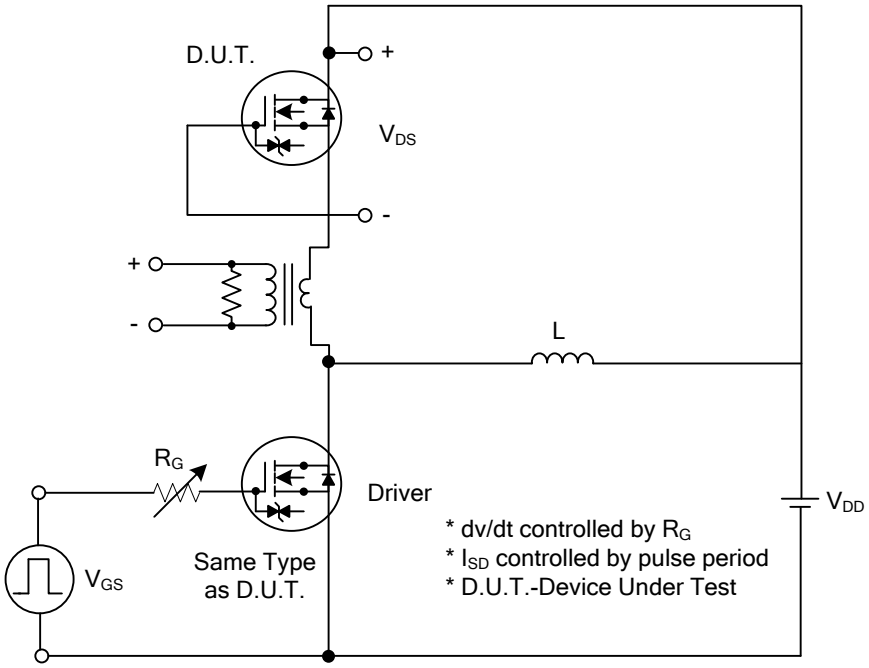
PARAMETER	SYMBOL	RATINGS	UNIT
Junction to Ambient	θ_{JA}	62.5	°C/W
Junction to Case	θ_{Jc}	5	°C/W

■ ELECTRICAL CHARACTERISTICS (T_C=25°C, unless otherwise specified)

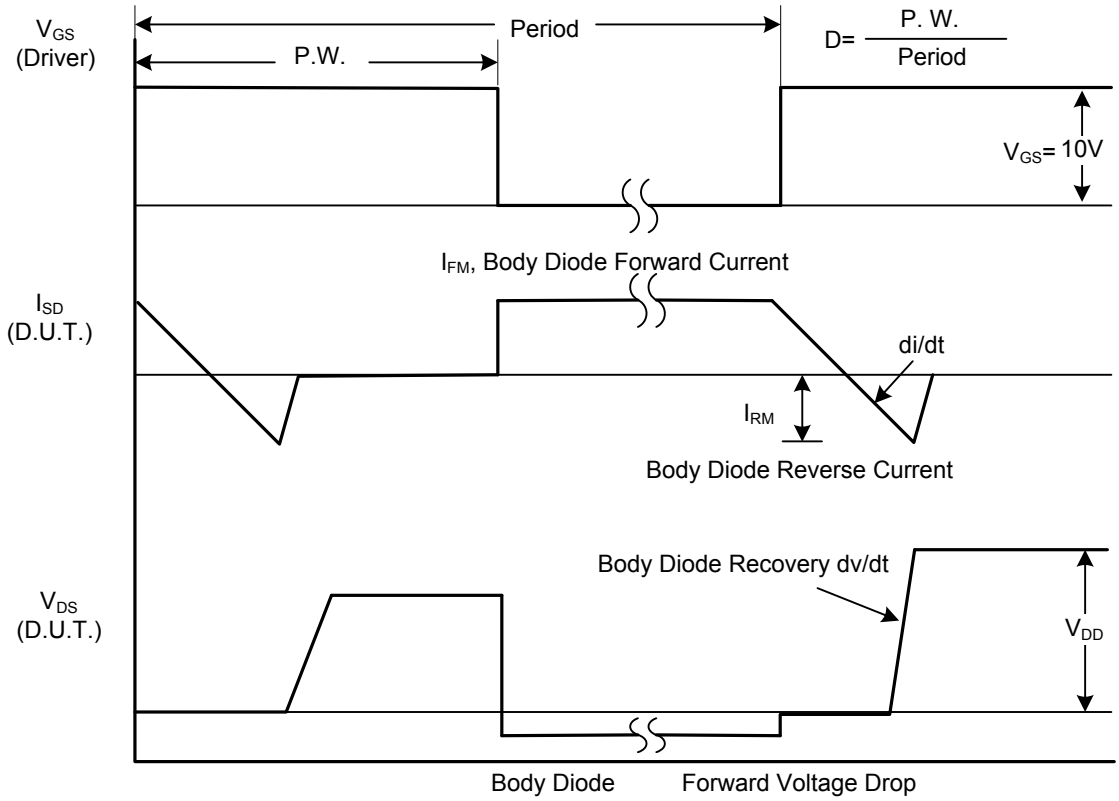
PARAMETER		SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT
OFF CHARACTERISTICS							
Drain-Source Breakdown Voltage		BV_{DSS}	I_D=250μA, V_{GS}=0V	900			V
Breakdown Voltage Temperature Coefficient		$\triangle BV_{DSS}/\triangle T_J$	Reference to 25°C, I_D=250μA		1.0		V/°C
Drain-Source Leakage Current		I_{DSS}	V_{DS}=900V, V_{GS}=0V			10	μA
			V_{DS}=720V, T_C=125°C			100	
Gate- Source Leakage Current	Forward	I_{GSS}	V_{GS}=+20V, V_{DS}=0V			5	μA
	Reverse		V_{GS}=-20V, V_{DS}=0V			-5	μA
ON CHARACTERISTICS							
Gate Threshold Voltage		$V_{GS(TH)}$	V_{DS}=V_{GS}, I_D=250μA	3.0		5.0	V
Static Drain-Source On-State Resistance		$R_{DS(ON)}$	V_{GS}=10V, I_D=1.1A		5.6	7.2	Ω
Forward Transconductance		g_{FS}	V_{DS}=50V, I_D=1.1A (Note 1)		2.0		S
DYNAMIC PARAMETERS							
Input Capacitance		C_{ISS}	V_{GS}=0V, V_{DS}=25V, f=1.0MHz		390	500	pF
Output Capacitance		C_{OSS}			45	60	pF
Reverse Transfer Capacitance		C_{RSS}			5.5	7.0	pF
SWITCHING PARAMETERS							
Total Gate Charge		Q_G	V_{GS}=10V, V_{DS}=720V, I_D=2.2A (Note 1,2)		12	15	nC
Gate to Source Charge		Q_{GS}			2.8		nC
Gate to Drain Charge		Q_{GD}			6.1		nC
Turn-ON Delay Time		$t_{D(ON)}$	V_{DD}=450V, I_D=2.2A, R_G=25Ω (Note 1,2)		15	40	ns
Rise Time		t_R			35	80	ns
Turn-OFF Delay Time		$t_{D(OFF)}$			20	50	ns
Fall-Time		t_F			30	70	ns
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS							
Maximum Continuous Drain-Source Diode Forward Current		I_S				2.2	A
Maximum Pulsed Drain-Source Diode Forward Current		I_{SM}				8.8	A
Drain-Source Diode Forward Voltage		V_{SD}	I_S=2.2A, V_{GS}=0V			1.4	V
Reverse Recovery Time		t_{rr}	I_S=2.2A,V_{GS}=0V,dI_F/dt=100A/μs (Note 1)		400		ns
Reverse Recovery Charge		Q_{RR}			1.6		μC

Note: 1. Pulse Test: Pulse width ≤ 300μs, Duty cycle ≤ 2%
2. Essentially independent of operating temperature

■ TEST CIRCUITS AND WAVEFORMS

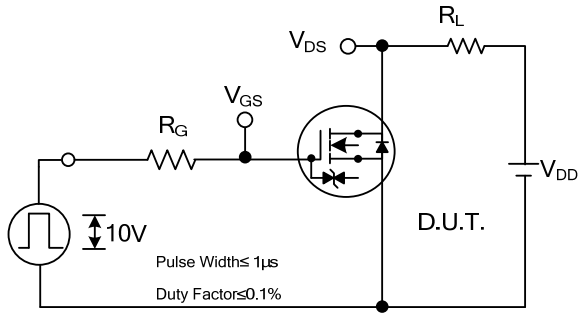


Peak Diode Recovery dv/dt Test Circuit

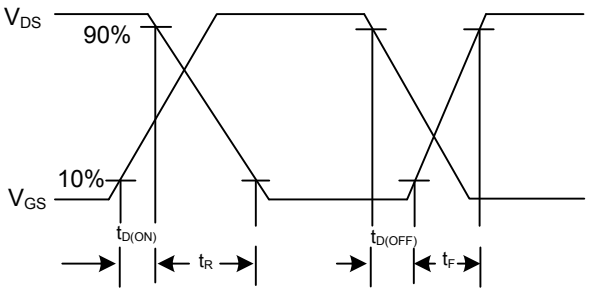


Peak Diode Recovery dv/dt Waveforms

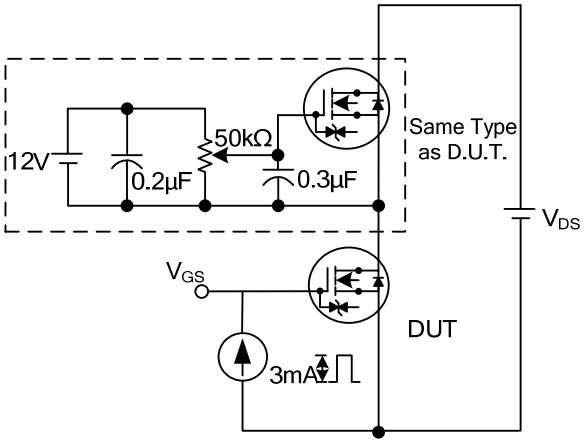
■ TEST CIRCUITS AND WAVEFORMS (Cont.)



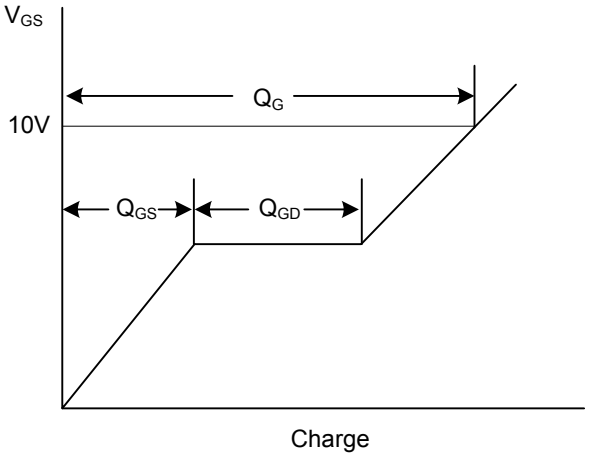
Switching Test Circuit



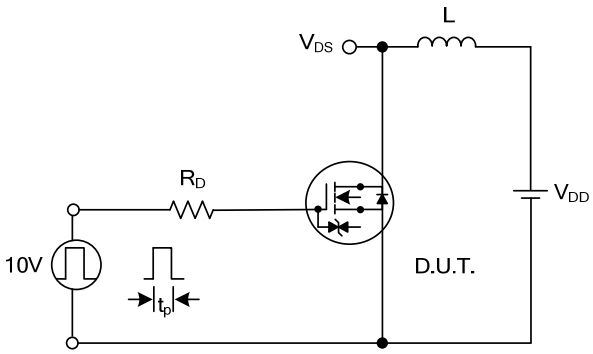
Switching Waveforms



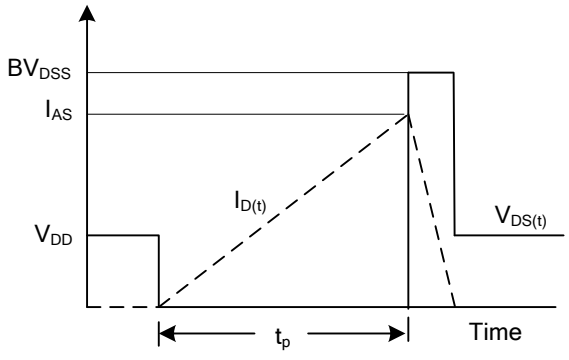
Gate Charge Test Circuit



Gate Charge Waveform



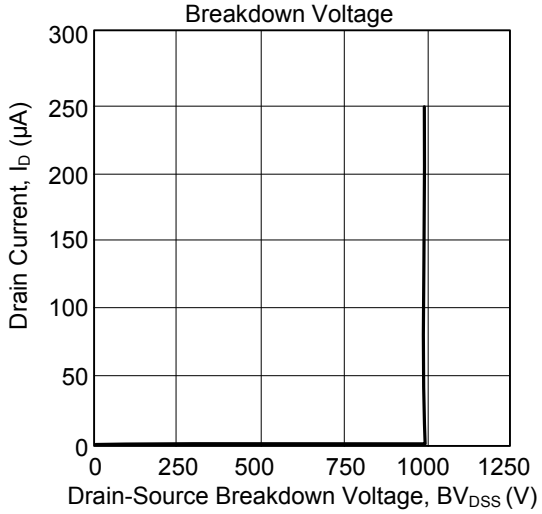
Unclamped Inductive Switching Test Circuit



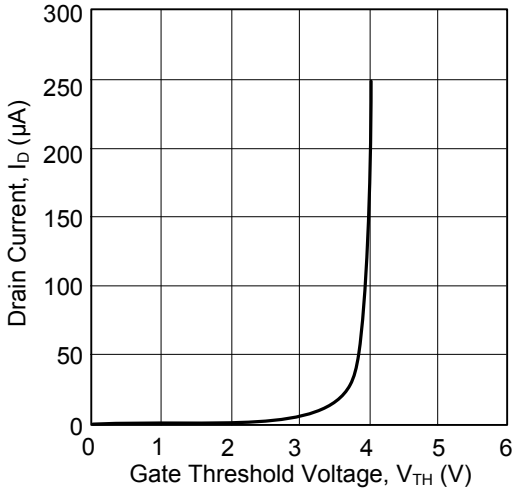
Unclamped Inductive Switching Waveforms

■ TYPICAL CHARACTERISTICS

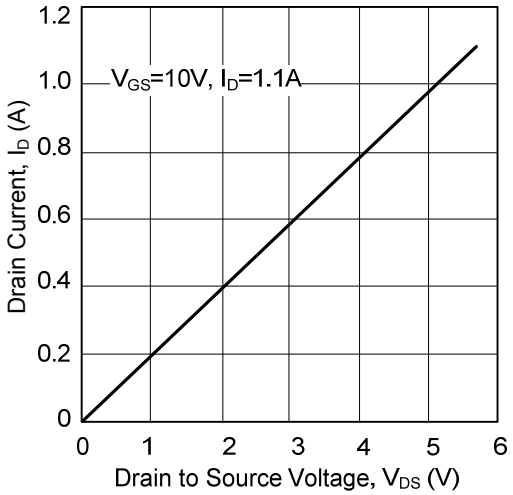
Drain Current vs. Drain-Source Breakdown Voltage



Drain Current vs. Gate Threshold Voltage



Drain-Source On-State Resistance Characteristics



Drain Current vs. Source to Drain Voltage